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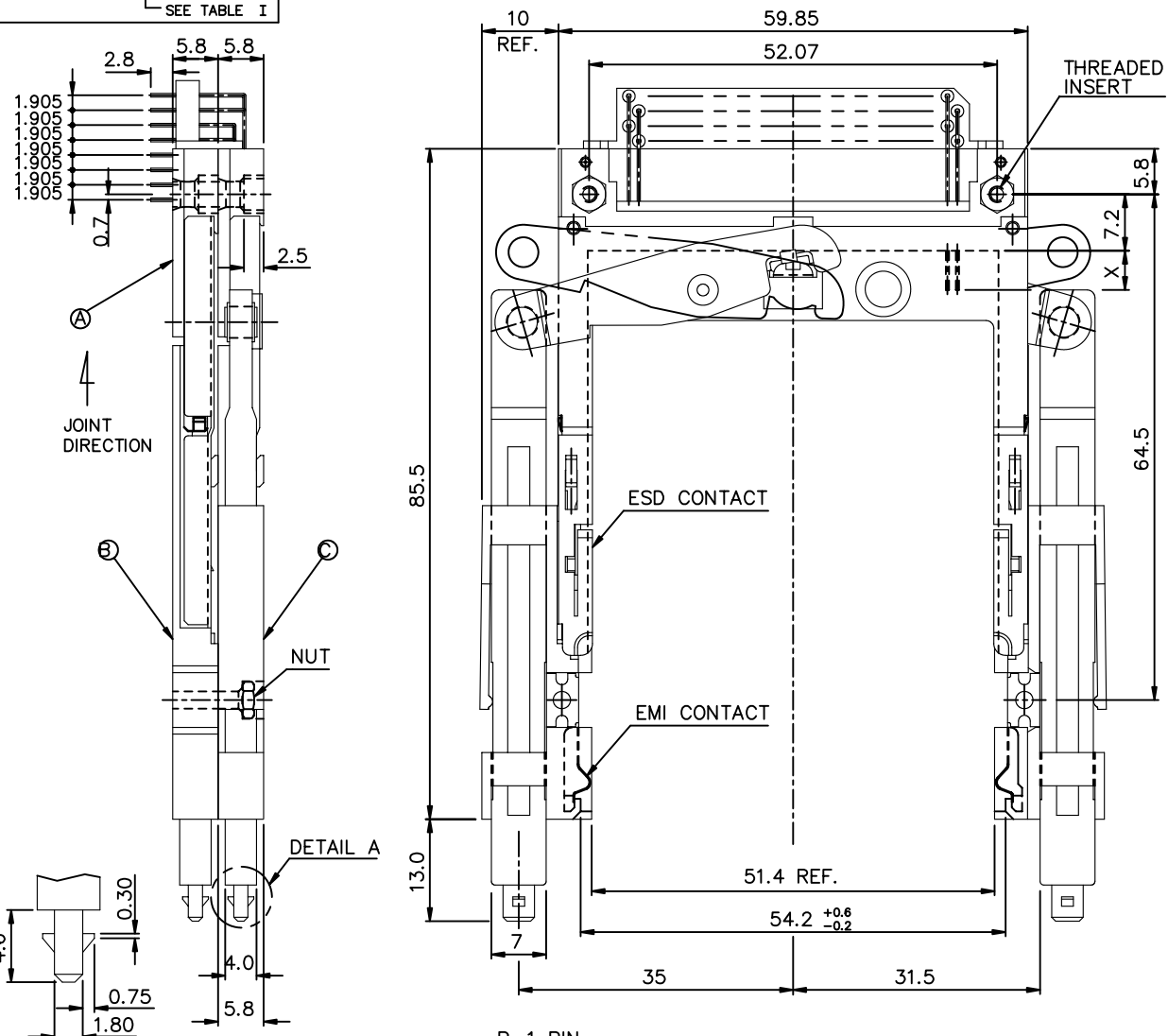
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



PRODUCT NO.
61150-100G*/100G*LF

SEE TABLE I



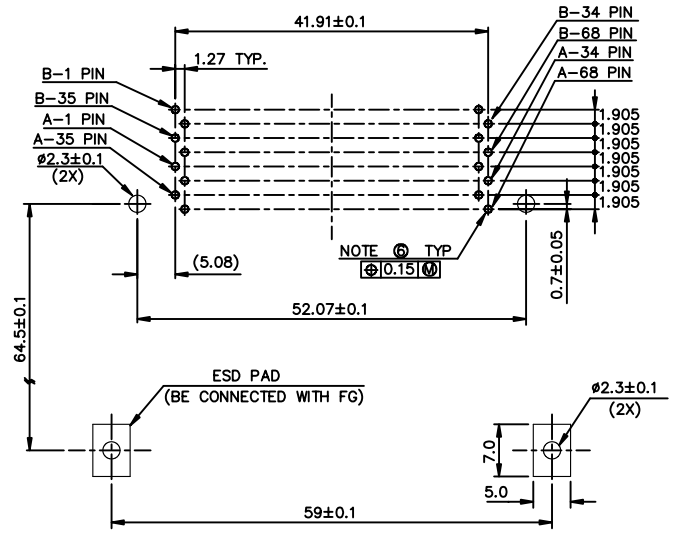
NOTES:

- EJECT FORCE : 3.5 Kg MAX.
- EJECT TRAVEL: 8.0mm
- MATERIAL
 - PART A (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
PIN : PHOSPHOR BRONZE
 - PART B AND C (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
PLATE : STAINLESS
EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)
UNDER PLATING : 0.5µm MIN. NI
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-NI
SOLDER TAIL (TIN LEAD OPTION) : 2.5µm MIN. Sn-Pb
SOLDER TAIL (LEAD FREE OPTION) : 2.5µm MIN. PURE TIN
- DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- RECOMMENDED DIAMETER IS Ø1.0, FOR PROCESSES USING PASTE REFLOW, HOLE MAYBE AS SMALL AS Ø0.79.
- IF LEAD FREE P/N, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- IF LEAD FREE P/N, THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

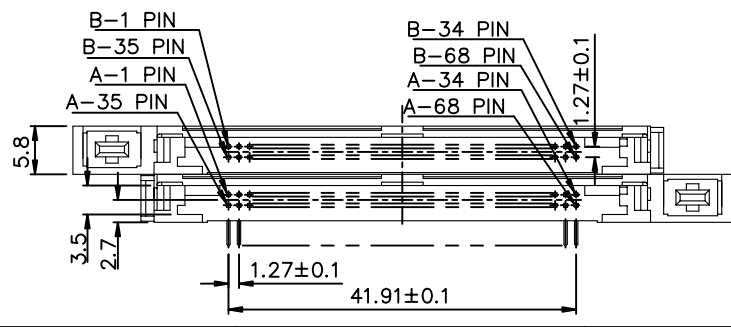
TABLE I

*	PUSH ROD COLOR
A	BLACK
H	NATURAL



USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

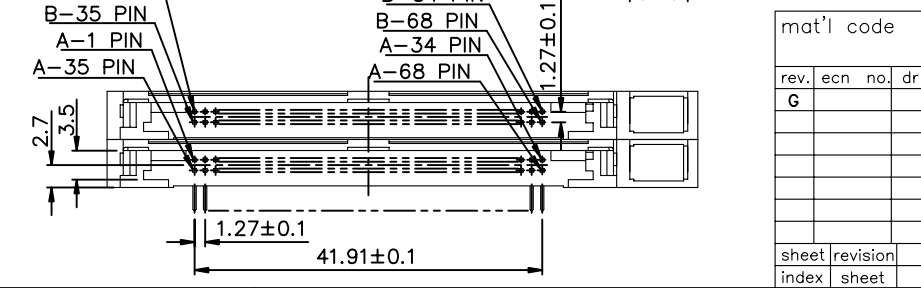
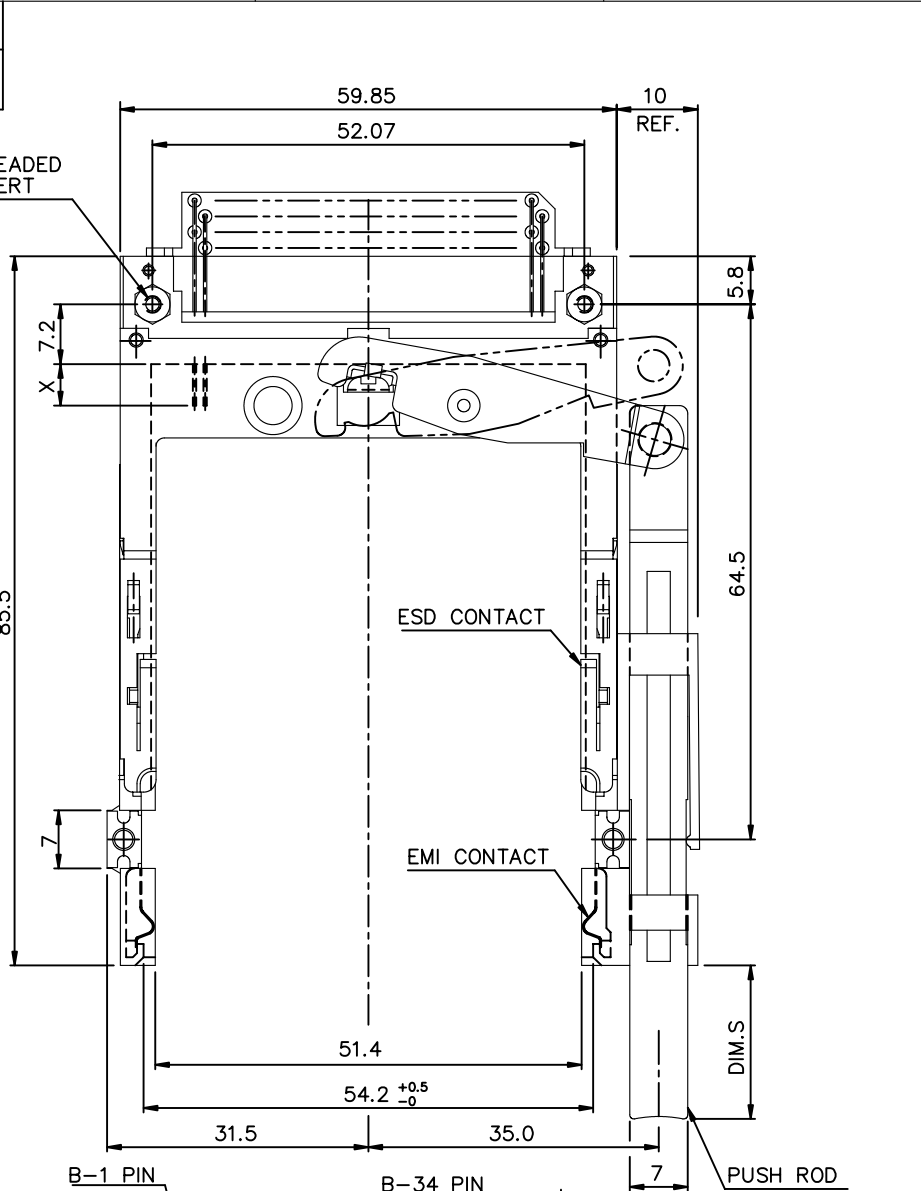
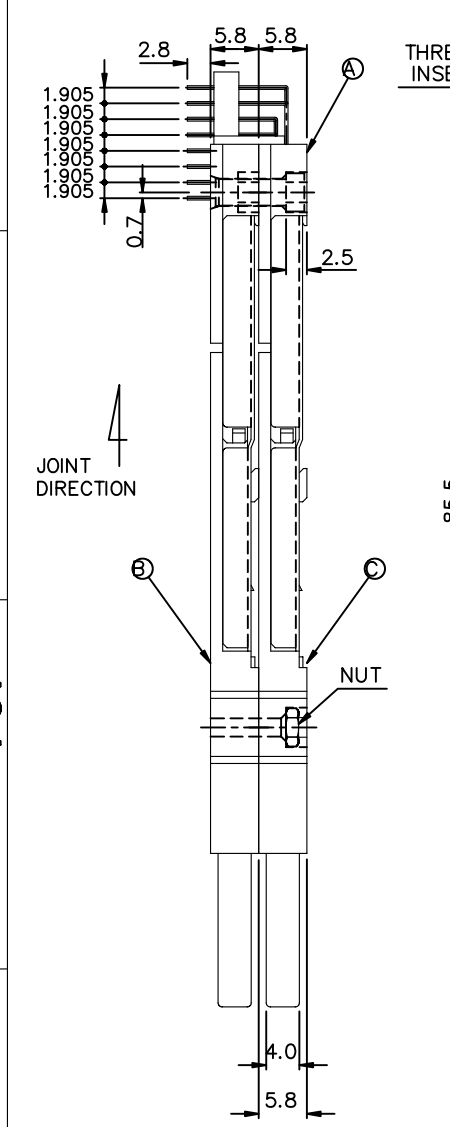
Ⓒ	EJECT MECH ASS'Y	94307-10G* SEE TABLE I
Ⓑ	EJECT MECH ASS'Y	88644-00G* SEE TABLE I
Ⓐ	HDR ASS'Y	92821-000/000LF
	DESCRIPTION	P/N



mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCI ELECTRONICS	
rev.	ecn no.	dr	date	linear	±0.30	projection	title
A	T55051	W L	08/02/95				88P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
B	T55066	W L	09/25/95				
C	T65007	W L	01/13/96	angles	± 2°		product family : PCMCIA code TWN
D	T60355	W L	09/02/96	dr	WENDY CHEN	08/02/95	
E	T10067	W L	03/05/01	enr	JOSEPH HSIA	08/02/95	scale sheet
F	T10092	W L	03/14/01	chr	JOSEPH HSIA	08/02/95	
G	N05-0059	W B	03/03/05	appd	JENN TSAO	08/02/95	
sheet	revision	G	G	G	G	G	
index	sheet	1	2	3	4	5	6

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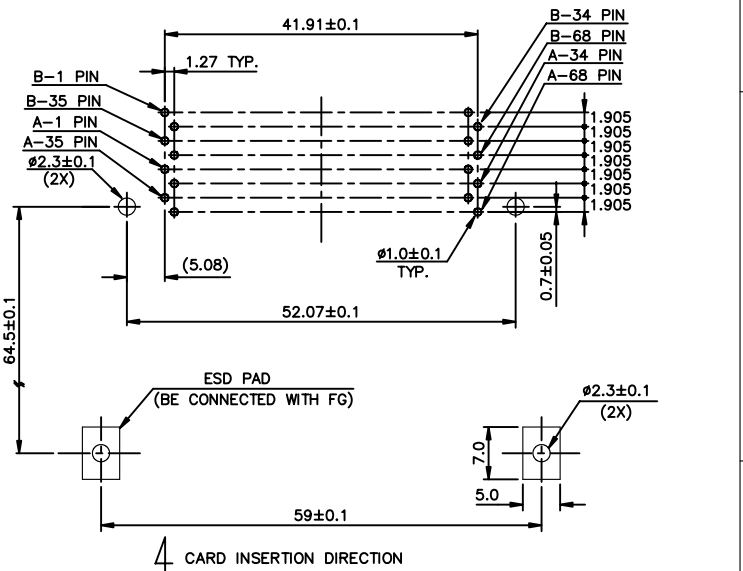
1 | PRODUCT NO.
 61150-200**/200**LF
 SEE TABLE I



- NOTES:
- EJECT FORCE : 3.5 Kg MAX.
 - EJECT TRAVEL: 8.0mm
 - MATERIAL
 - PART A (HEADER ASS'Y)
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK
 : LOCATOR ...GF 6/6 NYLON UL94-V0 BLACK
 PIN : PHOSPHOR BRONZE
 - PART B AND C (EJECT MECHANISM ASS'Y)
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
 : PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
 PLATE : STAINLESS
 EMI CONTACT: PHOSPHOR BRONZE
 - FINISH (PIN)
 UNDER PLATING : 0.5µm MIN. Ni
 CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
 SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN
 - DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
 - IF LEAD FREE P/N THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
 - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
 - TABLE I

**	DIM.S	PUSH ROD COLOR
CA	13.0	BLACK
CH	13.0	NATURAL
DA	15.2	BLACK
DH	15.2	NATURAL
EA	18.5	BLACK
EH	18.5	NATURAL
FA	21.0	BLACK
FH	21.0	NATURAL



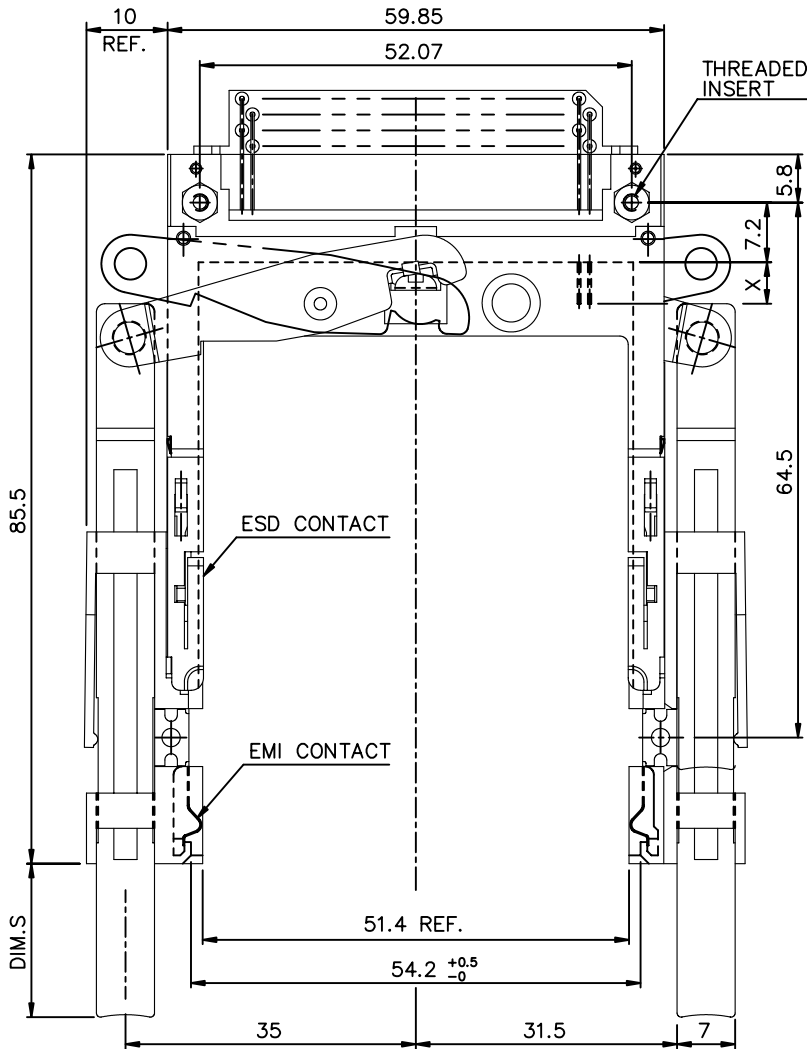
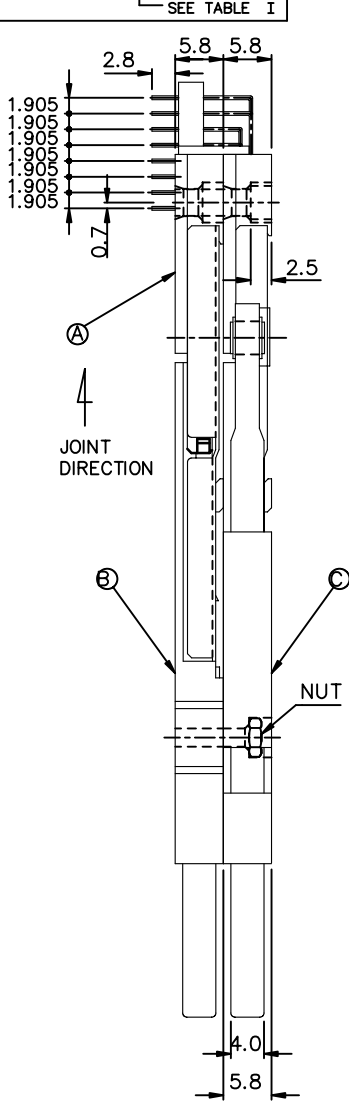
USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

DESCRIPTION	P/N
© EJECT MECH ASS'Y	94307-00** SEE TABLE I
Ⓑ EJECT MECH ASS'Y	88644-00** SEE TABLE I
Ⓐ HDR ASS'Y	92821-000/000LF

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCI	
rev.	ecn no.	dr	date	linear	±0.30	projection	title
G				angles	±2°	⊕	88P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
				dr	WENDY CHEN 01/10/96	unit	product family PCMCIA
				enr	JOSEPH HSIA 01/10/96	mm/inch	code
				chr	JOSEPH HSIA 01/10/96	scale	TWN
				appd	JENN TSAO 01/10/96	1.5:1	sheet
sheet	revision						2 OF
index	sheet						

PRODUCT NO.
61150-100**/100**LF

SEE TABLE I



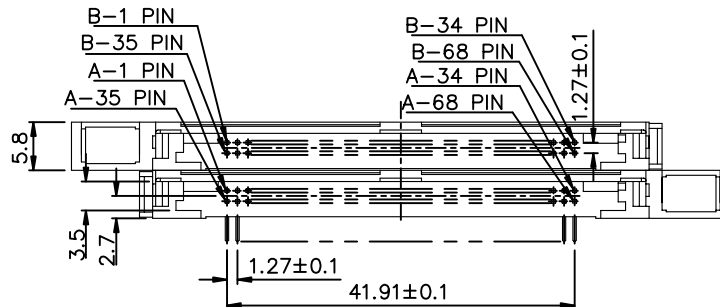
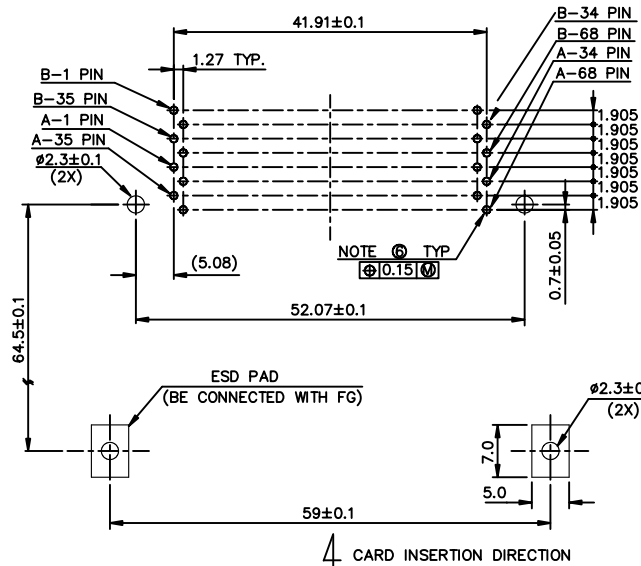
NOTES:

- EJECT FORCE : 3.5 Kg MAX.
- EJECT TRAVEL: 8.0mm
- MATERIAL
- PART A (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
PIN : PHOSPHOR BRONZE
- PART B AND C (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
PLATE : STAINLESS
EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)
UNDER PLATING : 0.5µm MIN. NI
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-NI
SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN
- DIM "X"
- RECOMMENDED DIAMETER IS Ø1.0, FOR PROCESSES USING PASTE REFLOW. HOLE MAYBE AS SMALL AS Ø0.79.
- IF LEAD FREE P/N, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

9. TABLE I

** DIM.	PUSH ROD COLOR
CA 13.0	BLACK
CH 13.0	NATURAL
DA 15.2	BLACK
DH 15.2	NATURAL
EA 18.5	BLACK
EH 18.5	NATURAL
FA 21.0	BLACK
FH 21.0	NATURAL



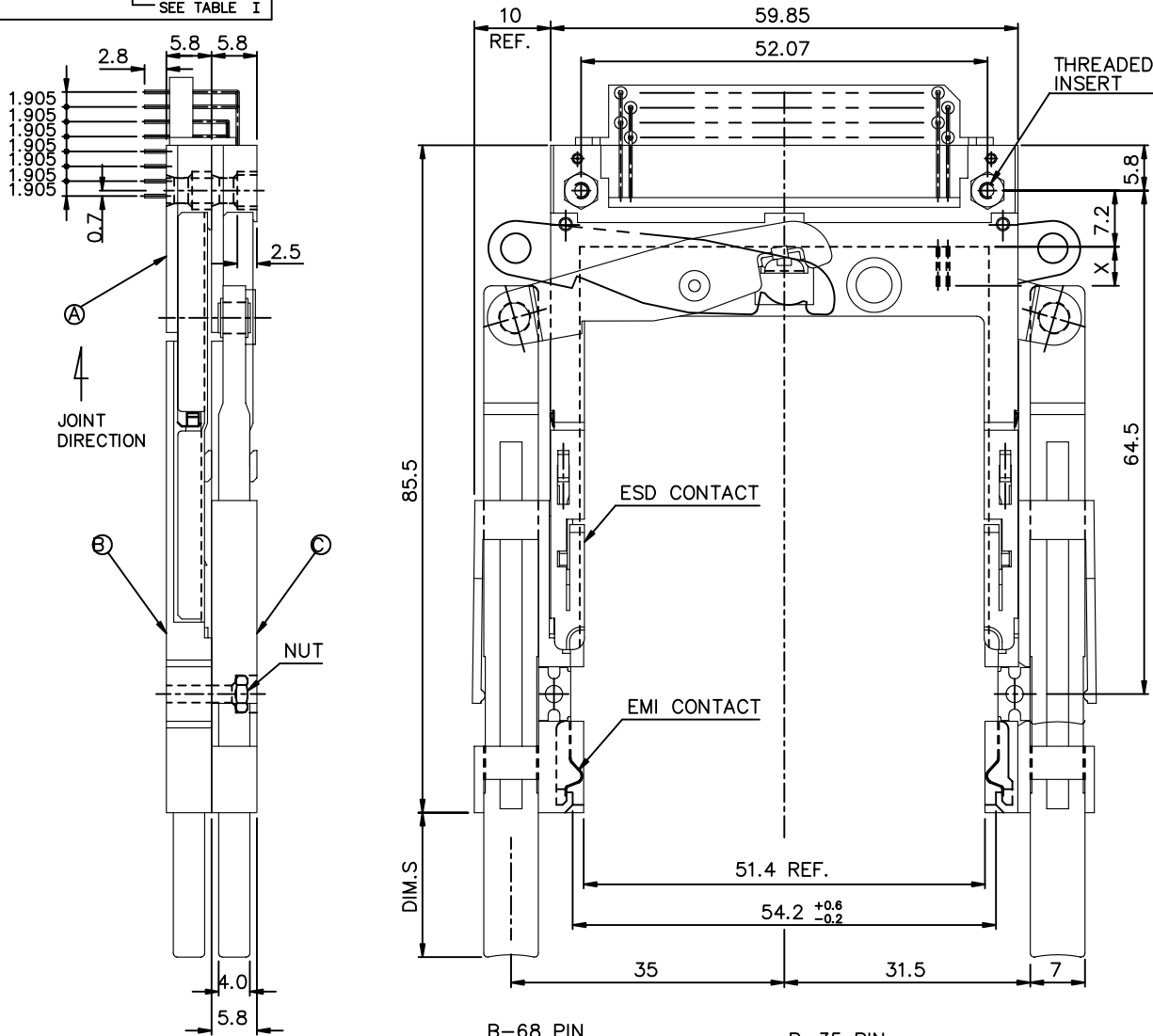
USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

Ⓒ	EJECT MECH ASS'Y	94307-10** SEE TABLE I
Ⓑ	EJECT MECH ASS'Y	88644-00** SEE TABLE I
Ⓐ	HDR ASS'Y	92821-000/000LF
	DESCRIPTION	P/N

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		 www.fciconnect.com	
rev.	ecn no.	dr	date	linear	±0.30	projection	title
D				angles	± 2°		88P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
		dr	WENDY CHEN	09/12/96		unit	product family
		enr	JOSEPH HSIA	09/12/96		mm/inch	PCMCIA
		chr	JOSEPH HSIA	09/12/96		scale	size
		appd	JENN TSAO	09/12/96		1.5:1	dwg no.
sheet	revision						61150
index	sheet						code
							TWN
							3 OF

PRODUCT NO.
61150-600**/600**LF

SEE TABLE I



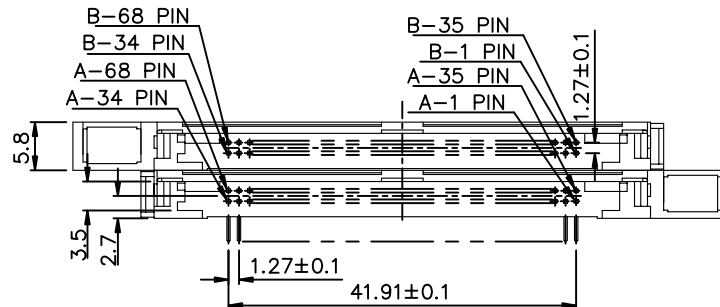
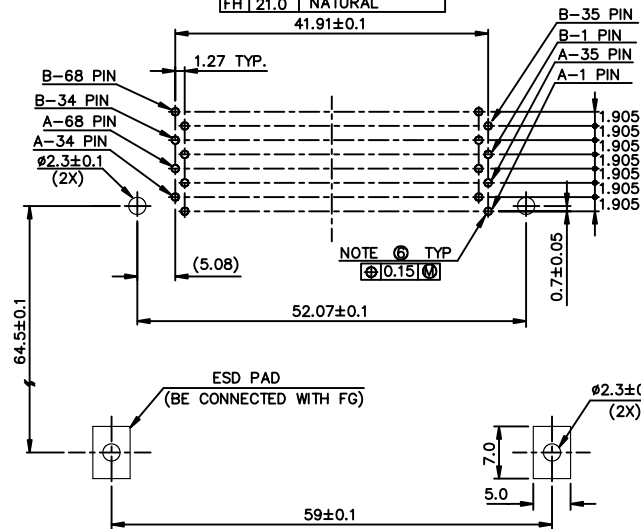
NOTES:

- EJECT FORCE : 3.5 Kg MAX.
- EJECT TRAVEL: 8.0mm
- MATERIAL
 - PART A (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
PIN : COPPER ALLOY
 - PART B AND C (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
PLATE : STAINLESS
EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)
UNDER PLATING : 0.5µm MIN. Ni
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
SOLDER TAIL(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER TAIL(LEAD FREE OPTION): 2.5µm MIN. PURE TIN
- DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- RECOMMENDED DIAMETER IS Ø1.0, FOR PROCESSES USING PASTE REFLOW, HOLE MAYBE AS SMALL AS Ø0.79.
- IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

9. TABLE I

** DIM.S	PUSH ROD COLOR
CA 13.0	BLACK
CH 13.0	NATURAL
DA 15.2	BLACK
DH 15.2	NATURAL
EA 18.5	BLACK
EH 18.5	NATURAL
FA 21.0	BLACK
FH 21.0	NATURAL



USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

Ⓒ	EJECT MECH ASS'Y	94307-10** SEE TABLE I
Ⓑ	EJECT MECH ASS'Y	88644-00** SEE TABLE I
Ⓐ	HDR ASS'Y	92821-500/500LF
	DESCRIPTION	P/N

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		ELECTRONICS	
rev.	ecn no.	dr	date	linear	±0.30	projection	title
G				linear			88P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
				angles	± 2°		
				dr	WENDY CHEN 12/20/00	unit	product family : PCMCIA
				enr	LEIF SHEN 12/20/00	mm/inch	code
				chr	JOSEPH HSIA 12/20/00	scale	TWN
				appd	JOSEPH HSIA 12/20/00	1.5:1	sheet
sheet	revision					A3	61150
index	sheet						4 OF

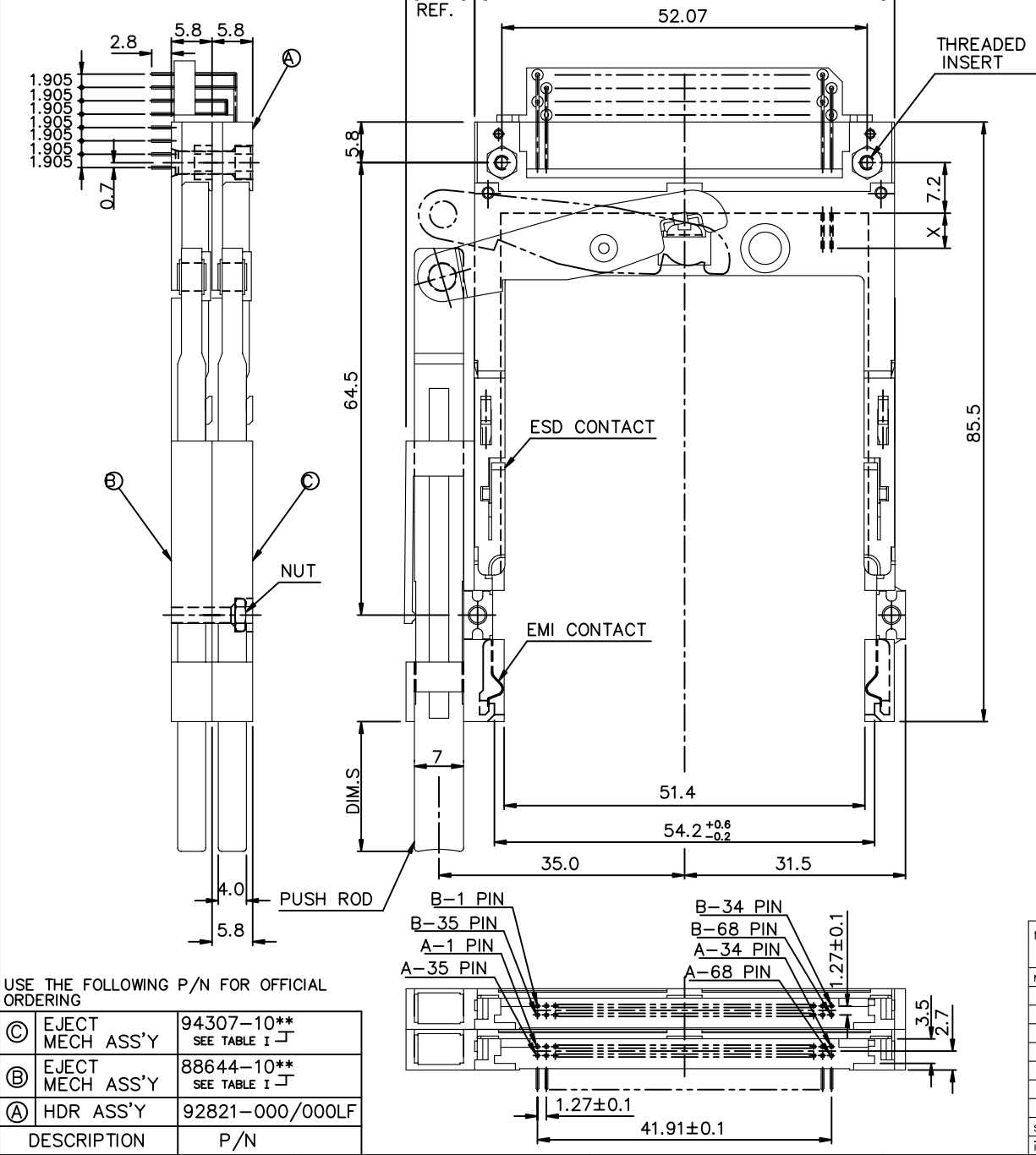
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PRODUCT NO.	
61150-300**/300**LF	SEE TABLE I

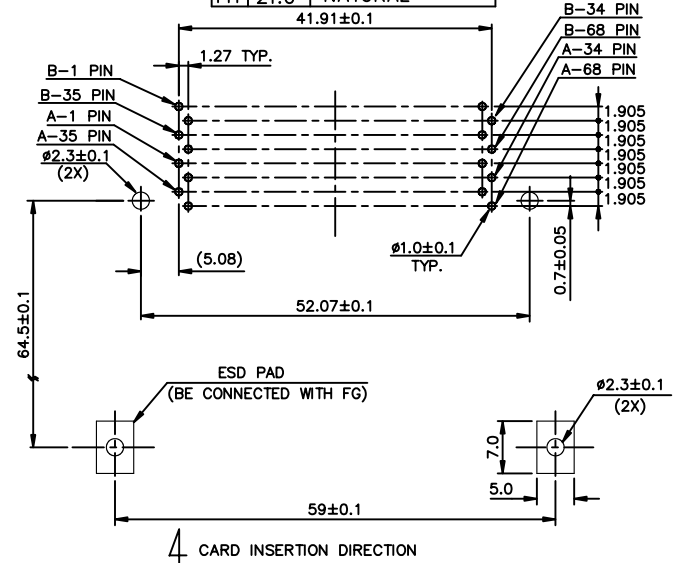


- NOTES:
- EJECT FORCE : 3.5 Kg MAX.
 - EJECT TRAVEL: 8.0mm
 - MATERIAL
 - 3.1 PART (A) (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK
 - 3.2 PART (B) AND (C) (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
 - PLATE : STAINLESS
EMI CONTACT: PHOSPHOR BRONZE
 - FINISH (PIN)
 - UNDER PLATING : 0.5µm MIN. Ni
 - CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
 - SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 - SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN
 - DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
 - IF LEAD FREE P.N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
 - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

8. TABLE I

** DIM.S	PUSH ROD COLOR
CA 13.0	BLACK
CH 13.0	NATURAL
DA 15.2	BLACK
DH 15.2	NATURAL
EA 18.5	BLACK
EH 18.5	NATURAL
FA 21.0	BLACK
FH 21.0	NATURAL

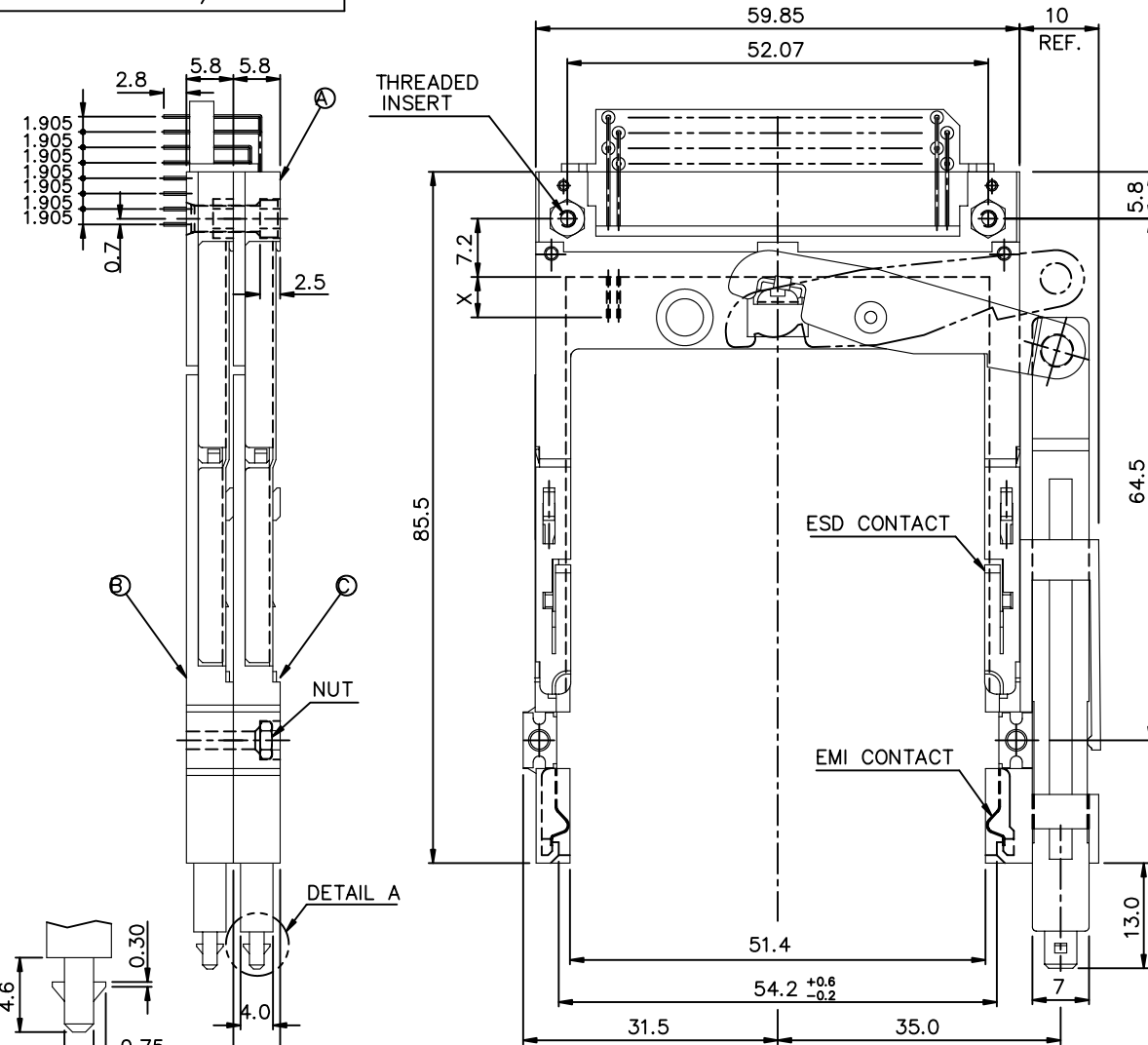


USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

(C)	EJECT MECH ASS'Y	94307-10** SEE TABLE I
(B)	EJECT MECH ASS'Y	88644-10** SEE TABLE I
(A)	HDR ASS'Y	92821-000/000LF
	DESCRIPTION	P/N

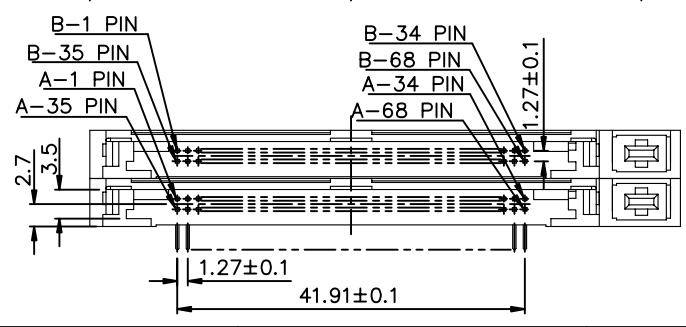
mat'l code	tolerance unless otherwise specified	CUSTOMER COPY	FCI ELECTRONICS	
rev. ecn no. dr date	linear ±0.30	projection	title	
G	angles ±2°	unit	68P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3	
	dr WENDY CHEN 03/05/01	mm/inch	product family : PCMCIA	code T'WN
	enr MINERVA WANG 03/05/01	scale	size dwg no.	sheet 5 of
	chr JOSEPH HSIA 03/05/01	1.5:1	A3	61150
	appd JOSEPH HSIA 03/05/01			
sheet revision index	revision sheet			

PRODUCT NO.
61150-200GA/200GALF



DETAIL A
USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

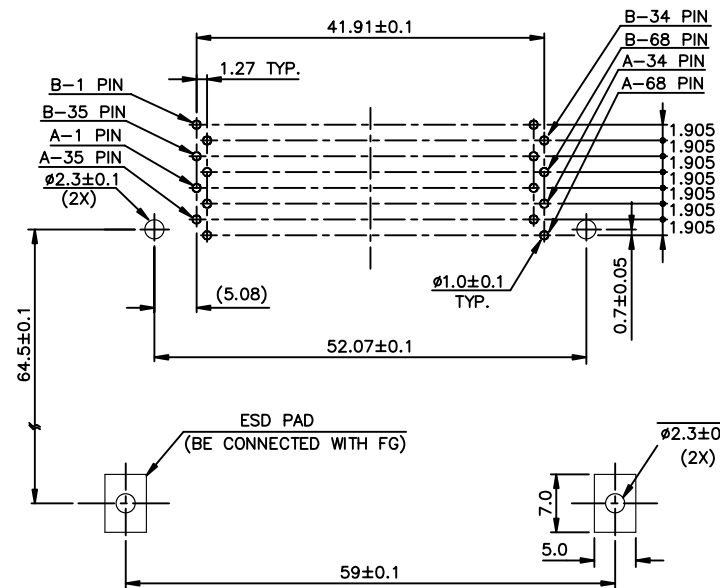
Ⓒ	EJECT MECH ASS'Y	94307-00GA
Ⓑ	EJECT MECH ASS'Y	88644-00GA
Ⓐ	HDR ASS'Y	92821-000/000LF
	DESCRIPTION	P/N



NOTES:

- EJECT FORCE : 3.5 Kg MAX.
- EJECT TRAVEL: 8.0mm
- MATERIAL
 - PART Ⓐ (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
: LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
PIN : COPPER ALLOY
 - PART Ⓑ AND Ⓒ (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
: PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
PLATE : STAINLESS
EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)
UNDER PLATING : 0.5µm MIN. Ni
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN
- DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- IF LEAD FREE P/N THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



4 CARD INSERTION DIRECTION

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		ELECTRONICS	
rev. ecn no. dr date		linear ±0.30		projection		FCI	
G		angles ±2'		title		68P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3	
		dr WENDY CHEN 03/14/01		unit mm/inch		product family PCMCIA code	
		enrg MINERVA WANG 03/14/01		size dwg no.			
		chr JOSEPH HSIA 03/14/01		scale 1.5:1		A3 61150	
		appd JOSEPH HSIA 03/14/01				sheet 6 OF	
sheet revision							
index sheet							